



PRESS RELEASE

BE Semiconductor Industries N.V. Announces 2024 Second Quarter Conference Call and Webcast Details

Duiven, the Netherlands, July 18, 2024 - BE Semiconductor Industries N.V. ("the Company" or "Besì"), (Euronext Amsterdam: BESI; OTC: BESIY), a leading manufacturer of assembly equipment for the semiconductor industry, will release its results for the second quarter ended June 30, 2024, on Thursday July 25, 2024 at 7.00 a.m. CET (1.00 a.m. EDT).

A conference call to discuss the Company's 2024 second quarter results will be held on Thursday July 25, 2024, at 4.00 p.m. CET (10.00 a.m. EDT).

Interested parties can pre-register using this [link](#) to receive the dial-in number and a personal PIN which are required to get access to the conference call. The audio webcast can be accessed via: www.besi.com, where also a replay will be available shortly after the call.

About Besì

Besì is a leading supplier of semiconductor assembly equipment for the global semiconductor and electronics industries offering high levels of accuracy, productivity and reliability at a low cost of ownership. The Company develops leading edge assembly processes and equipment for leadframe, substrate and wafer level packaging applications in a wide range of end-user markets including electronics, mobile internet, cloud server, computing, automotive, industrial, LED and solar energy. Customers are primarily leading semiconductor manufacturers, assembly subcontractors and electronics and industrial companies. Besì's ordinary shares are listed on Euronext Amsterdam (symbol: BESI). Its Level 1 ADRs are listed on the OTC markets (symbol: BESIY) and its headquarters are located in Duiven, the Netherlands. For more information, please visit our website at www.besi.com.

Contacts:

Richard Blickman, President & CEO

Leon Verweijen, SVP Finance

Claudia Vissers, Executive Secretary/IR coordinator

Edmond Franco, VP Corporate Development/US IR coordinator

Tel. (+31) 26 319 4500

investor.relations@besi.com